DNA-Based Nanoelectronic Manufacturing Technologies Richard A. Kiehl

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acknowledgments

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DNA double-crossover molecule



2D DNA scaffolding based on DX molecule "tiles"



"materials growth technology": tile analysis by gel electrophoresis



assembly of DNA scaffolding



$4 \ \mu m \ x \ 4 \ \mu m$

1 µm x 1 µm

"device process technology": oligoDNA-nanoparticle conjugates



(5 nm diameter)



(5-10 DNA strands/particle)

2-step process: scaffolding assembly > component attachment



hybridization of nanocomponents to a pre-assembled DNA scaffolding

as-grown DNA crystal



after hybridization



$0.5 \ \mu m \ x \ 0.5 \ \mu m$

0.5 µm x 0.5 µm

high-yield assembly of nanocomponent arrays

before hybridization



after hybridization



1 µm x 1 µm

1 µm x 1 µm

TEM image confirming assembly of gold nanoparticles



DNA-templated self-assembly of metallic nanocomponent arrays on a surface



J. D. Le, Y. Pinto, N. C. Seeman, K. Musier-Forsyth, T. A. Taton, and R. A. Kiehl, Nano Lett. 4, 2343, Dec 2004.

electronics applications: information processing in 2D arrays

tunneling phase logic cellular nonlinear network



T. Yang, R. A. Kiehl, L. O. Chua, Intl. J. Bifurcation and Chaos 11, 2895 (2001)

- First demonstration of hybridization of nanoelectronic components to a pre-assembled 2D DNA scaffolding.
- High-yield assembly of DNA-Au nanocomponent arrays

Scaffolding: 2D DNA crystal with hybridization sites Nanocomponents: oligoDNA-Au conjugates

• Step toward technology for *precision*, *programmable* assembly of nanoelectronic circuitry.